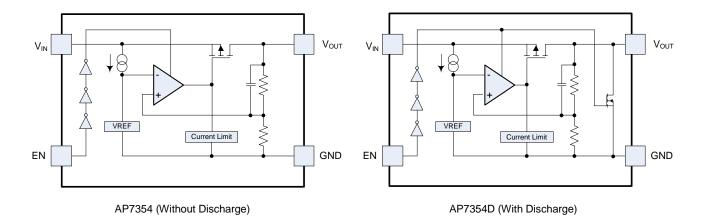


Pin Description

	Pin Numbe	er		
SOT25	SOT23	X2-DFN1010-4 (Type B)	Pin Name	Function
3	_	3	EN	Chip Enable — This should be driven either high or low and must not be floating. Driving EN high enables regulator output, while pulling it low places regulator into shutdown mode.
2	3	2	GND	Ground
5	2	1	V _{оит}	Output Voltage
1	1	4	Vin	Power Input
_	_	Center Pad	_	No connection or ground. Note: Chip Ground must be through GND pin.

Functional Block Diagram



EN Pin Not Available on SOT23



Absolute Maximum Ratings (Note 5)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
VIN	Input Voltage	6.0	V
V _{EN}	Input Voltage at EN Pin	6.0	V
Vouт	Output Voltage to GND	-0.3 to V _{IN} +0.3	V
TA	Operating Ambient Temperature	-40 to +85	°C
TJ	Maximum Junction Temperature	+125	°C
T _{STG}	Storage Temperature	-55 to +125	°C
P _D	Power Dissipation (Note 6)	315	mW

Notes:

Recommended Operating Conditions

Symbol	Parameter	Min	Мах	Unit
Vin	Input Voltage	2.0	5.5	V
lout	Output Current	0	150	mA
TA	Operating Ambient Temperature	-40	+85	°C

Stresses beyond those listed under Absolute Maximum Ratings can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.

^{6.} This is based on an application temperature of +40°C. Derate 3.75mW per °C for each degree above +40°C.



 $\textbf{Electrical Characteristics} \ \ (@T_A = +25^{\circ}C, \ V_{EN} = V_{IN} = V_{OUT} + 1V \ (1.5V < V_{OUT} \le 4.5V), \ V_{EN} = V_{IN} = 2.5V \ (V_{OUT} \le 1.5V), \ I_{OUT} = 1mA, \ I_{OUT} = 1mA,$ $C_{IN} = C_{OUT} = 0.1 \mu F$, unless otherwise specified.)

Parameter	Conditions		Min	Тур	Max	Unit
Input Voltage	$T_A = -40$ °C to +85°C		2.0	_	5.5	V
	Vout > 2.0V	T _A = +25°C	-1	_	+1	
	Iout = 1mA	$T_A = -40$ °C to +85°C	-2	_	+2	%
Output Voltage Accuracy	V _{OUT} ≤ 2.0V	T _A = +25°C	-40	_	40	
	I _{OUT} = 1mA	T _A = -40°C to +85°C	-80	_	80	mV
Line Regulation (ΔVουτ/ΔVικ/Vουτ)	MAX (Vout + 1.0V (All Versions Exce	$(7, 2.5V) \le V_{IN} \le 5.5V$ ept 4.5V)	_	0.02	0.1	%/V
Local Develotion (AV.	1mA ≤ I _{OUT} ≤ 150r	mA (All Versions Except 4.5V)	-40	_	40	mV
Load Regulation (ΔV _{OUT})	1mA ≤ I _{OUT} ≤ 150r	mA (Applicable to 4.5V Version)	-55	_	55	mV
Short Circuit Current Limit (Note 7)	Vout = 0V		_	60	_	mA
Quiescent Current (Note 8)	Iout = 0mA			0.25	0.6	μΑ
ISTANDBY	Set EN Low, No Lo	oad	_	0.02	0.2	μΑ
Output Current	_		150	_	_	mA
		V _{OUT} = 1.1V	_	0.70	1.00	
		Vout = 1.2V	_	0.60	0.90	
		Vout = 1.5V	_	0.43	0.75	
	louт = 150mA	Vout = 1.8V	_	0.33	0.60	V
		V _{OUT} = 1.85V	_	0.32	0.58	
Dropout Voltage (Note 9)		Vout = 2.2V	_	0.27	0.52	
		Vout = 2.5V	_	0.22	0.48	
		Vout = 2.8V	_	0.19	0.40	
		Vout = 3.0V	_	0.18	0.35	
		V _{OUT} = 3.3V	_	0.16	0.35	
		Vout = 4.5V	_	0.14	0.35	
EN Input Low Voltage	_		_	_	0.4	V
EN Input High Voltage	_		1.0	_	5.5	V
Active Output Discharge Resistance (Note 10)	VIN = 4.0V, VEN =	0V		35	_	Ω
		SOT23	_	170	_	
Θ _{JA} Thermal Resistance Junction-to-Ambient	(Note 11)	SOT25	_	162	_	°C/W
		X2-DFN1010-4 (Type B)	_	295	_	
		SOT23	_	43	_	
Θ _{JC} Thermal Resistance Junction-to-Case	(Note 11)	SOT25	_	38	_	°C/W
		X2-DFN1010-4 (Type B)	_	120	_	1

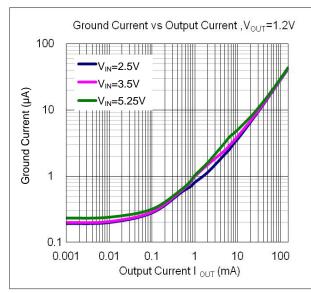
Notes:

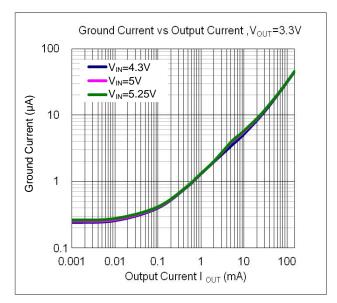
- 7. Short-circuit current is measured with V_{OUT} pulled to GND.
- 8. Quiescent current defined as the difference in current between the input and the output.
- 9. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.

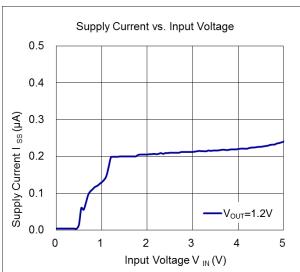
 10. AP7354 is available with two options: built-in discharge (AP7354D) and non-discharge (AP7354).
- 11. Test condition: Device mounted on 1" x 1" FR-4 MRP substrate PCB, 2oz copper, with minimum recommended pad layout.

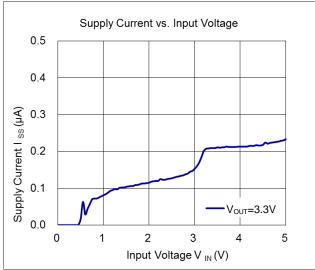


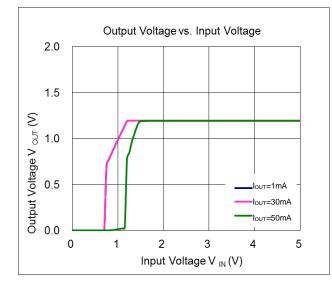
Performance Characteristics

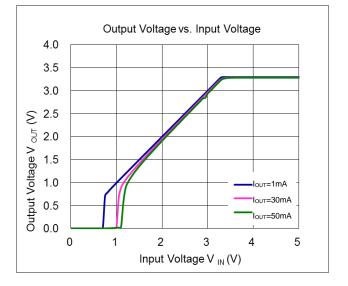




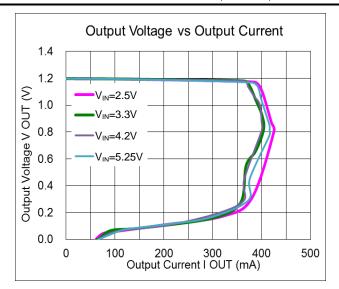


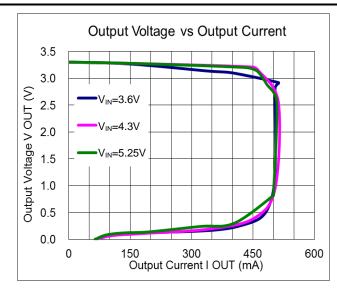


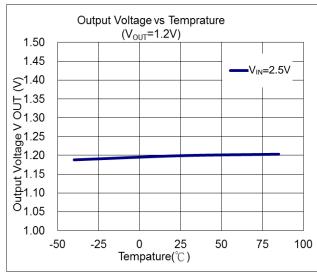


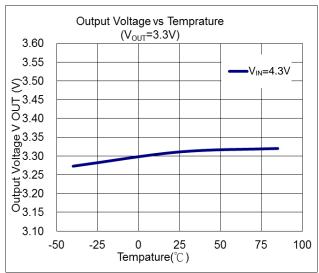


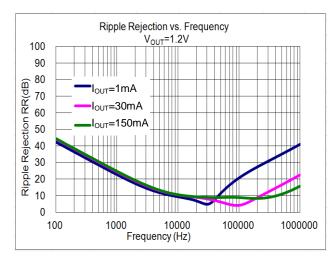


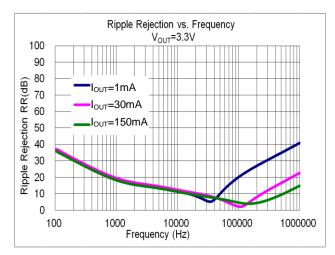






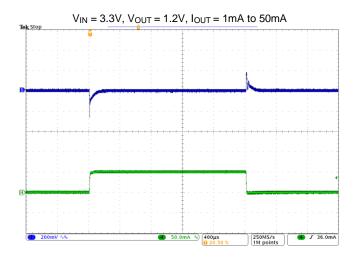


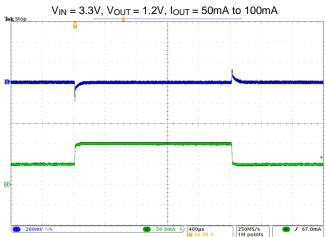


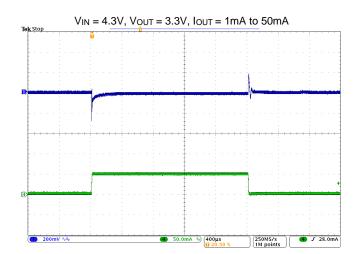


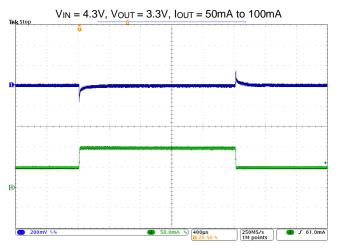


Load Transient Response ($C_{IN} = C_{OUT} = 0.1 \mu F$, $t_R = t_F = 5.0 \mu s$, unless otherwise specified.)







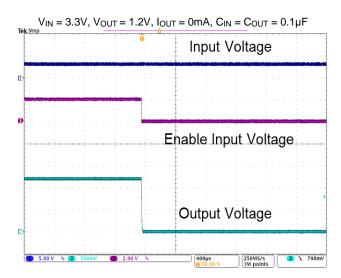


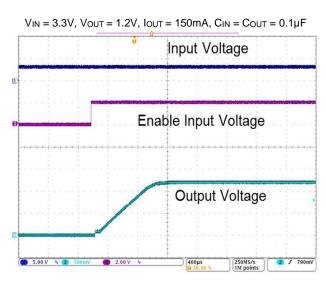


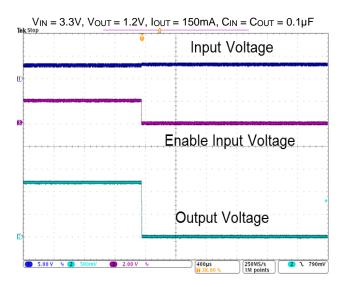
TURN ON

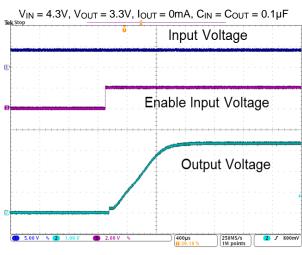
V_{IN} = 3.3V, V_{OUT} = 1.2V, I_{OUT} = 0mA, C_{IN} = C_{OUT} = 0.1μF Input Voltage Enable Input Voltage Output Voltage

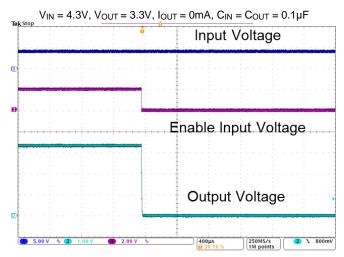
TURN OFF









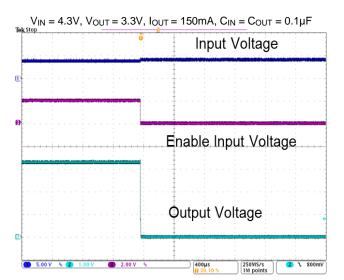




TURN ON

VIN = 4.3V, VOUT = 3.3V, IOUT = 150mA, CIN = COUT = 0.1µF Input Voltage Enable Input Voltage Output Voltage

TURN OFF





Application Information

Output Capacitor

An output capacitor (C_{OUT}) is required to improve transient response and maintain stability. The AP7354 is stable with very small ceramic output capacitors. The equivalent series resistance (ESR) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin. Care must be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor (C_{IN}). A minimum $0.1\mu F$ ceramic capacitor is recommended between V_{IN} and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pin.

Enable Control

The AP7354 is turned on by setting the EN pin high, and is turned off by pulling them low. If this feature is not used, the EN pin should be tied to V_{IN} pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the *Electrical Characteristics* section.

Layout Considerations

For good ground loop and stability, the input and output capacitors must be located close to the input, output, and GND pin of the device. The regulator GND pin must be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace must be used for large current paths from VIN to VOUT and load circuit.

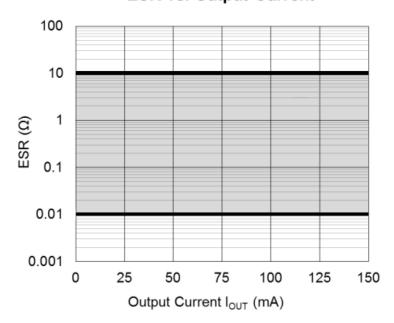
ESR vs. Output Current

A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between IouT (output current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph.

Measurement Conditions:

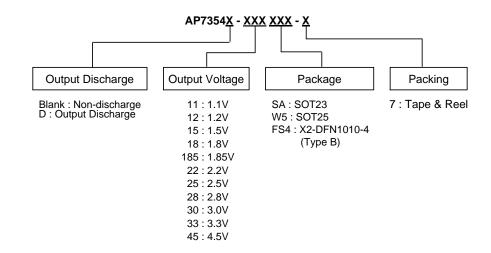
Frequency Band: 10Hz to 2MHz
 Temperature: -40°C to +85°C

ESR vs. Output Current





Ordering Information (Note 12)



2	0.0700	SOT25	SOT25	7" Tape and Reel		
Output Voltage	SOT23	Without Discharge	With Discharge	Quantity	Part Number Suffix	
1.2	AP7354-12SA-7	AP7354-12W5-7	AP7354D-12W5-7	3000/Tape & Reel	-7	
1.5	AP7354-15SA-7	AP7354-15W5-7	AP7354D-15W5-7	3000/Tape & Reel	-7	
1.8	AP7354-18SA-7	AP7354-18W5-7	AP7354D-18W5-7	3000/Tape & Reel	-7	
1.85	AP7354-185SA-7	AP7354-185W5-7	AP7354D-185W5-7	3000/Tape & Reel	-7	
2.2	AP7354-22SA-7	_	_	3000/Tape & Reel	-7	
2.5	AP7354-25SA-7	AP7354-25W5-7	AP7354D-25W5-7	3000/Tape & Reel	-7	
2.8	AP7354-28SA-7	AP7354-28W5-7	AP7354D-28W5-7	3000/Tape & Reel	-7	
3.0	AP7354-30SA-7	AP7354-30W5-7	AP7354D-30W5-7	3000/Tape & Reel	-7	
3.3	AP7354-33SA-7	AP7354-33W5-7	AP7354D-33W5-7	3000/Tape & Reel	-7	
4.5	AP7354-45SA-7	AP7354-45W5-7	AP7354D-45W5-7	3000/Tape & Reel	-7	

Output	X2-DFN1010-4 (Type B)	X2-DFN1010-4 (Type B)	7" Tape	7" Tape and Reel		
Voltage	Without Discharge	With Discharge	Quantity	Part Number Suffix		
1.1	AP7354-11FS4-7	AP7354D-11FS4-7	5000/Tape & Reel	-7		
1.2	AP7354-12FS4-7	AP7354D-12FS4-7	5000/Tape & Reel	-7		
1.5	AP7354-15FS4-7	AP7354D-15FS4-7	5000/Tape & Reel	-7		
1.8	AP7354-18FS4-7	AP7354D-18FS4-7	5000/Tape & Reel	-7		
1.85	AP7354-185FS4-7	AP7354D-185FS4-7	5000/Tape & Reel	-7		
2.5	AP7354-25FS4-7	AP7354D-25FS4-7	5000/Tape & Reel	-7		
2.8	AP7354-28FS4-7	AP7354D-28FS4-7	5000/Tape & Reel	-7		
3.0	AP7354-30FS4-7	AP7354D-30FS4-7	5000/Tape & Reel	-7		
3.3	AP7354-33FS4-7	AP7354D-33FS4-7	5000/Tape & Reel	-7		
4.5	AP7354-45FS4-7	AP7354D-45FS4-7	5000/Tape & Reel	-7		

Note: 12. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

(1) SOT23

(Top View)

3

XXX Y W X

XXX: Identification Code

Y : Year 0 to 9

 \underline{W} : Week: A to Z: 1 to 26 week;

a to z: 27 to 52 week; z represents

52 and 53 week \underline{X} : Internal Code

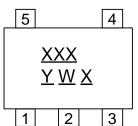
Part Number	Package	Identification Code
AP7354-12SA-7	SOT23	A8A
AP7354-15SA-7	SOT23	A8B
AP7354-18SA-7	SOT23	A8C
AP7354-185SA-7	SOT23	A8D
AP7354-22SA-7	SOT23	A8K
AP7354-25SA-7	SOT23	A8E
AP7354-28SA-7	SOT23	A8F
AP7354-30SA-7	SOT23	A8G
AP7354-33SA-7	SOT23	A8H
AP7354-45SA-7	SOT23	A8J



Marking Information (continued)

(2) SOT25

(Top View)



XXX: Identification Code

Y: Year 0 to 9

 \underline{W} : Week: A to Z: 1 to 26 week;

a to z : 27 to 52 week; z represents 52 and 53 week

X: Internal Code

Part Number	Package	Identification Code
AP7354-12W5-7	SOT25	A8A
AP7354-15W5-7	SOT25	A8B
AP7354-18W5-7	SOT25	A8C
AP7354-185W5-7	SOT25	A8D
AP7354-25W5-7	SOT25	A8E
AP7354-28W5-7	SOT25	A8F
AP7354-30W5-7	SOT25	A8G
AP7354-33W5-7	SOT25	A8H
AP7354-45W5-7	SOT25	A8J
AP7354D-12W5-7	SOT25	A9A
AP7354D-15W5-7	SOT25	A9B
AP7354D-18W5-7	SOT25	A9C
AP7354D-185W5-7	SOT25	A9D
AP7354D-25W5-7	SOT25	A9E
AP7354D-28W5-7	SOT25	A9F
AP7354D-30W5-7	SOT25	A9G
AP7354D-33W5-7	SOT25	A9H
AP7354D-45W5-7	SOT25	A9J



Marking Information (continued)

(3) X2-DFN1010-4 (Type B)

(Top View)

<u>XXX</u> <u>Y W X</u> XXX: Identification Code

Y: Year: 0~9

W: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week \underline{X} : Internal Code

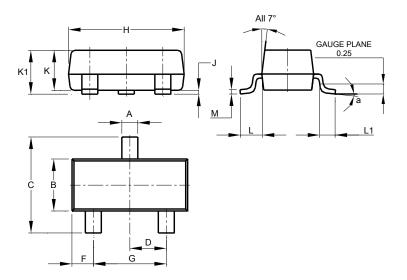
Part Number	V _{OUT}	Package	Identification Code
AP7354-11FS4-7	1.1V	X2-DFN1010-4 (Type B)	A8M
AP7354-12FS4-7	1.2V	X2-DFN1010-4 (Type B)	A8A
AP7354-15FS4-7	1.5V	X2-DFN1010-4 (Type B)	A8B
AP7354-18FS4-7	1.8V	X2-DFN1010-4 (Type B)	A8C
AP7354-185FS4-7	1.85V	X2-DFN1010-4 (Type B)	A8D
AP7354-25FS4-7	2.5V	X2-DFN1010-4 (Type B)	A8E
AP7354-28FS4-7	2.8V	X2-DFN1010-4 (Type B)	A8F
AP7354-30FS4-7	3.0V	X2-DFN1010-4 (Type B)	A8G
AP7354-33FS4-7	3.3V	X2-DFN1010-4 (Type B)	A8H
AP7354-45FS4-7	4.5V	X2-DFN1010-4 (Type B)	A8J
AP7354D-11FS4-7	1.1V	X2-DFN1010-4 (Type B)	A9M
AP7354D-12FS4-7	1.2V	X2-DFN1010-4 (Type B)	A9A
AP7354D-15FS4-7	1.5V	X2-DFN1010-4 (Type B)	A9B
AP7354D-18FS4-7	1.8V	X2-DFN1010-4 (Type B)	A9C
AP7354D-185FS4-7	1.85V	X2-DFN1010-4 (Type B)	A9D
AP7354D-25FS4-7	2.5V	X2-DFN1010-4 (Type B)	A9E
AP7354D-28FS4-7	2.8V	X2-DFN1010-4 (Type B)	A9F
AP7354D-30FS4-7	3.0V	X2-DFN1010-4 (Type B)	A9G
AP7354D-33FS4-7	3.3V	X2-DFN1010-4 (Type B)	А9Н
AP7354D-45FS4-7	4.5V	X2-DFN1010-4 (Type B)	A9J



Package Outline Dimensions

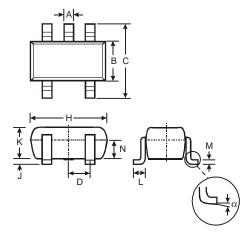
 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

(1) Package Type: SOT23



	SO	T23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а	0°	8°	
All	Dimens	ions in	mm

(2) Package Type: SOT25



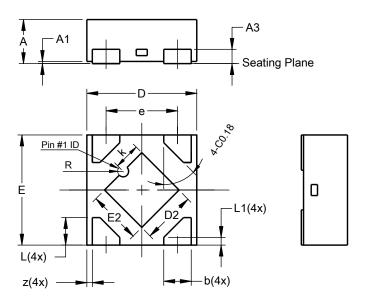
	SOT	25	
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
В	1.50	1.70	1.60
O	2.70	3.00	2.80
O	-	1	0.95
Η	2.90	3.10	3.00
ے	0.013	0.10	0.05
K	1.00	1.30	1.10
Г	0.35	0.55	0.40
М	0.10	0.20	0.15
Z	0.70	0.80	0.75
α	0°	8°	-
All D	imensi	ons in	mm



Package Outline Dimensions (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: X2-DFN1010-4 (Type B)

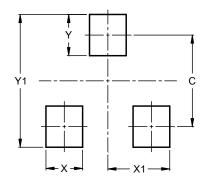


X2-	X2-DFN1010-4 (Type B)					
Dim	Min	Max	Тур			
Α	-	0.40	0.39			
A1	0.00	0.05	0.02			
A3	-	-	0.13			
b	0.20	0.30	0.25			
D	0.95	1.05	1.00			
D2	0.43	0.53	0.48			
Е	0.95	1.05	1.00			
E2	0.43	0.53	0.48			
е	-	-	0.65			
k	0.19	0.29	0.24			
L	0.20	0.30	0.25			
L1	0.02	0.12	0.07			
R	0.02	0.08	0.05			
Z	-	-	0.050			
All	Dimensi	ions in	mm			

Suggested Pad Layout

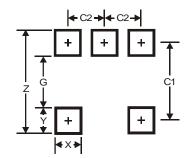
 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

(1) Package Type: SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2 9

(2) Package Type: SOT25



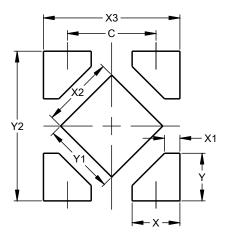
Dimensions	Value
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95



Suggested Pad Layout (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: X2-DFN1010-4 (Type B)



Dimensions	Value (in mm)	
С	0.650	
Х	0.350	
X1	0.112	
X2	0.530	
Х3	1.00	
Υ	0.350	
Y1	0.530	
Y2	1.100	



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